MCR12DSM

MCR12DSN

Motorola Preferred Devices

SCRs 12 AMPERES RMS

Silicon Controlled Rectifiers Reverse Blocking Thyristors

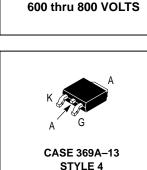
Designed for high volume, low cost, industrial and consumer applications such as motor control; process control; temperature, light and speed control.

- Small Size
- Passivated Die for Reliability and Uniformity
- Low Level Triggering and Holding Characteristics
- Available in Two Package Styles Surface Mount Lead Form — Case 369A Miniature Plastic Package — Straight Leads — Case 369

ORDERING INFORMATION

- To Obtain "DPAK" in Surface Mount Leadform (Case 369A) Shipped in Sleeves — No Suffix, i.e. MCR12DSN Shipped in 16 mm Tape and Reel — Add "T4" Suffix to Device Number, i.e. MCR12DSNT4
- To Obtain "DPAK" in Straight Lead Version (Case 369) Shipped in Sleeves Add "–1" Suffix to Device Number, i.e. MCR12DSN–1

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)



Rating		Symbol	Value	Unit
Peak Repetitive Off–State Voltage (1) Peak Repetitive Reverse Voltage $(T_J = -40 \text{ to } 110^\circ\text{C}, R_{GK} = 1.0 \text{ K}\Omega)$	MCR12DSM MCR12DSN	Vdrm Vrrm	600 800	Volts
On–State RMS Current (All Conduction Angles; T _C = 75°C)		^I T(RMS)	12	Amps
Average On–State Current (All Conduction Angles; $T_C = 75^{\circ}C$)		IT(AV)	7.6	
Peak Non–Repetitive Surge Current (One Half Cycle, 60 Hz, T _J = 110°C)		ITSM	100	
Circuit Fusing Consideration (t = 8.3 msec)		l ² t	41	A ² sec
Peak Gate Power (Pulse Width ≤ 10 μsec, T _C = 75°C)		P _{GM}	5.0	Watts
Average Gate Power (t = 8.3 msec, T _C = 75°C)		PG(AV)	0.5	
Peak Gate Current (Pulse Width \leq 10 µsec, T _C = 75°C)		IGM	2.0	Amps
Operating Junction Temperature Range		TJ	-40 to 110	°C
Storage Temperature Range		T _{stg}	-40 to 150]

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance — Junction to Case — Junction to Ambient — Junction to Ambient ⁽²⁾	R _θ JC R _θ JA R _θ JA	2.2 88 80	°C/W
Maximum Lead Temperature for Soldering Purposes (3)	TL	260	°C

(1) V_{DRM} for all types can be applied on a continuous basis. Ratings apply for negative gate voltage or R_{GK} = 1.0 KΩ; positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the device are exceeded.

(2) Surface mounted on minimum recommended pad size.

(3) 1/8" from case for 10 seconds.

Preferred devices are Motorola recommended choices for future use and best overall value.



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Characteristics	Symbol	Min	Тур	Max	Unit
Peak Reverse Gate Blocking Voltage $(I_{GR} = 10 \ \mu A)$	VGRM	10	12.5	18	Volts
Peak Forward Blocking CurrentPeak Reverse Blocking Current $(V_{AK} = Rated V_{DRM} \text{ or } V_{RRM})$ (1) $T_J = 2$ $T_J = 1$				10 500	μΑ
Peak Reverse Gate Blocking Current (V _{GR} = 10 V)	IRGM	_	_	1.2	μΑ
Peak On–State Voltage ⁽²⁾ (I _{TM} = 24 A)	VTM	_	1.4	2.1	Volts
Gate Trigger Current (Continuous dc) ⁽³⁾ ($V_D = 12 V, R_L = 100 \Omega, T_J = 25^{\circ}C$) ($V_D = 12 V, R_L = 100 \Omega, T_J = -40^{\circ}C$)	IGT	5.0 —	12 —	200 300	μΑ
Gate Trigger Voltage (Continuous dc) $(V_D = 12 \text{ V}, \text{ R}_L = 100 \Omega, \text{ T}_J = 25^{\circ}\text{C})$ $(V_D = 12 \text{ V}, \text{ R}_L = 100 \Omega, \text{ T}_J = -40^{\circ}\text{C})$ $(V_D = 12 \text{ V}, \text{ R}_L = 100 \Omega, \text{ T}_J = 110^{\circ}\text{C})$	V _{GT}	0.45 — 0.2	0.65 — —	1.0 1.5 —	Volts
Holding Current (V _D = 12 V, l(init) = 200 mA, T _J = 25°C) (V _D = 12 V, l(init) = 200 mA, T _J = -40 °C)	Ч	0.5	1.0	6.0 10	mA
Latching Current ($V_D = 12 \text{ V}, \text{ I}_G = 2.0 \text{ mA}, \text{ T}_J = 25^{\circ}\text{C}$) ($V_D = 12 \text{ V}, \text{ I}_G = 2.0 \text{ mA}, \text{ T}_J = -40^{\circ}\text{C}$)	ΙL	0.5 —	1.0	6.0 10	mA

DYNAMIC CHARACTERISTICS

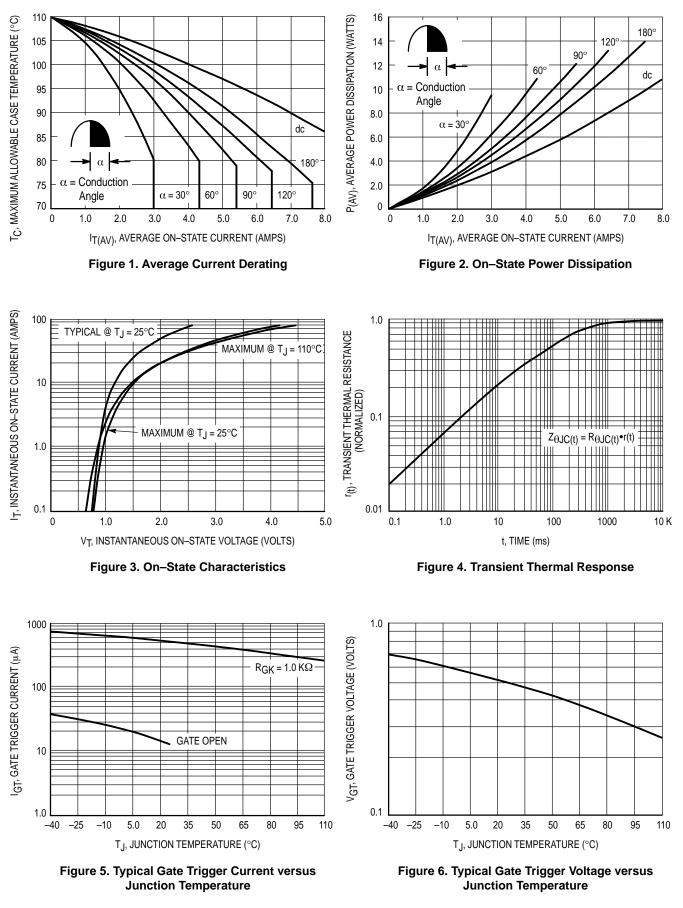
Characteristics	Symbol	Min	Тур	Max	Unit
Total Turn–On Time (Source Voltage = 12 V, R_S = 6.0 K Ω , I_T = 16 A(pk), R_{GK} = 1.0 K Ω) (V _D = Rated V _{DRM} , Rise Time = 20 ns, Pulse Width = 10 µs)	tgt		2.0	5.0	μs
Critical Rate of Rise of Off–State Voltage ($V_D = 0.67 \times Rated V_{DRM}$, Exponential Waveform, $R_{GK} = 1.0 K\Omega$, $T_J = 110^{\circ}C$)	dv/dt	2.0	10	_	V/µs

(1) Ratings apply for negative gate voltage or R_{GK} = 1.0 KΩ. Devices shall not have a positive gate voltage concurrently with a negative voltage on the anode. Devices should not be tested with a constant current source for forward and reverse blocking capability such that the voltage applied exceeds the rated blocking voltage.

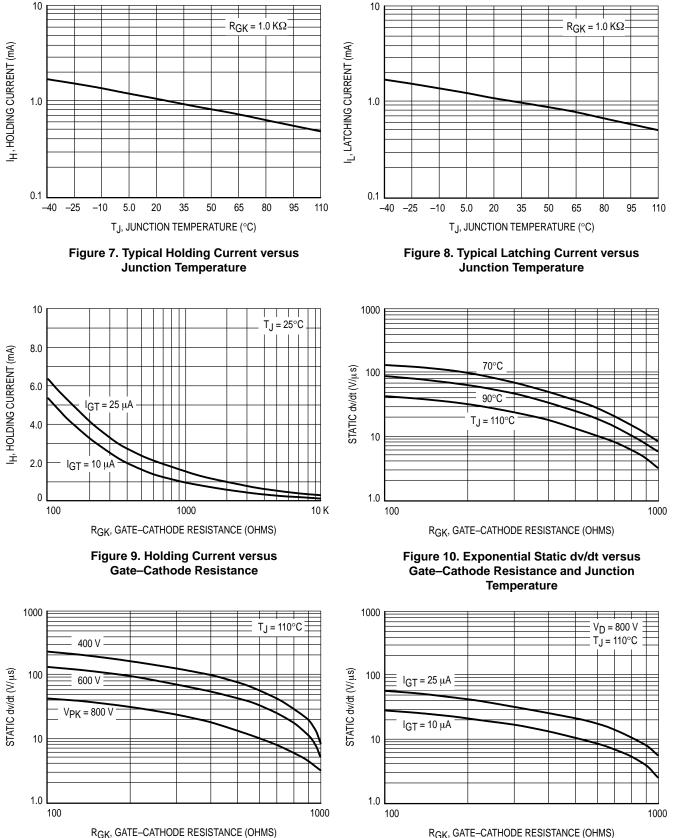
(2) Pulse Test; Pulse Width \leq 2.0 msec, Duty Cycle \leq 2%.

(3) Does not include R_{GK} current.

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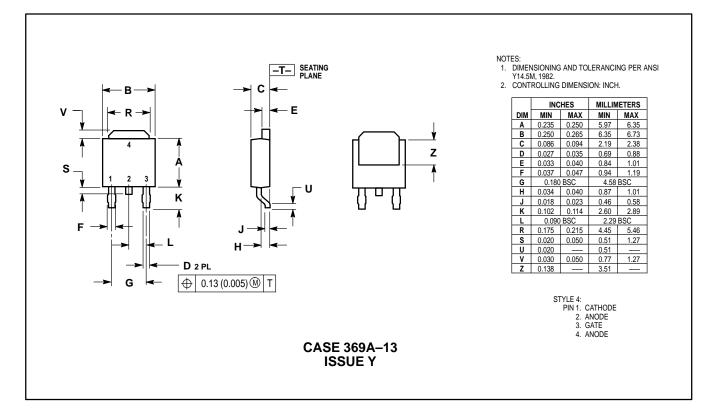


RGK, GATE-CATHODE RESISTANCE (OHMS)



Figure 11. Exponential Static dv/dt versus Gate-Cathode Resistance and Peak Voltage

PACKAGE DIMENSIONS



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